### 505304233 01/30/2019

# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT5351013

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
SATORU SUGIMOTO	01/29/2019
HIROKI HOSAKA	01/29/2019
HAYATO OISHI	01/29/2019

### **RECEIVING PARTY DATA**

Name:	MICRON TECHNOLOGY, INC.
Street Address:	8000 SOUTH FEDERAL WAY
Internal Address:	MS 1-525
City:	BOISE
State/Country:	IDAHO
Postal Code:	83716

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	16262087

### **CORRESPONDENCE DATA**

**Fax Number:** (509)838-3424

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

**Phone:** 509-624-4276

Email:docketing@wellsstjohn.comCorrespondent Name:WELLS ST. JOHN, P.S.Address Line 1:601 W. MAIN AVENUE

Address Line 2: SUITE 600

Address Line 4: SPOKANE, WASHINGTON 99201

ATTORNEY DOCKET NUMBER:	MI22-6791
NAME OF SUBMITTER:	CHERYL A. THOMPSON
SIGNATURE:	/Cheryl A. Thompson/
DATE SIGNED:	01/30/2019

**Total Attachments: 6** 

source=Assignment#page1.tif source=Assignment#page2.tif

PATENT 505304233 REEL: 048191 FRAME: 0161



PATENT REEL: 048191 FRAME: 0162

## <u>ASSIGNMENT</u>

# PARTIES TO THE ASSIGNMENT:

### INVENTORS:

Satoru Sugimoto c/o Micron Memory Japan, G.K. 8th Floor, Shinagawa Season Terrace, 1-2-70, Konan, Minato-ku, Tokyo 108-0075 Japan

Hiroki Hosaka c/o Micron Memory Japan, G.K. 8th Floor, Shinagawa Season Terrace, 1-2-70, Konan, Minato-ku, Tokyo 108-0075 Japan

Hayato Oishi c/o Micron Memory Japan, G.K. 8th Floor, Shinagawa Season Terrace, 1-2-70, Konan, Minato-ku, Tokyo 108-0075 Japan

ASSIGNEE:
Micron Technology, Inc.
MS 1-525
8000 South Federal Way
Boise, ID 83716
United States

### BACKGROUND OF THIS ASSIGNMENT:

Inventors have conceived certain new and useful inventions disclosed in a United States patent application titled Integrated Assemblies Having Capacitive Units, and Having Resistive Structures Coupled with the Capacitive Units.

MI22-6791 2018-1365.00/US 1 of 6

PATENT REEL: 048191 FRAME: 0163 Micron Technology, Inc. (hereinafter referred to as "ASSIGNEE") desires to acquire the entire right, title and interest in said inventions and

with respect to any Letters Patent(s) that may be granted with respect to the

inventions in both the United States and in all foreign countries.

THE PARTIES AGREE AS FOLLOWS:

In consideration of good and valuable consideration, the receipt,

sufficiency and adequacy of which is hereby acknowledged, INVENTORS

have sold, assigned and transferred, and by these present do hereby sell,

assign and transfer to ASSIGNEE the entire right, title and interest in the

above-identified inventions and patent application(s) and to any reissues,

renewals, divisions or continuations of the application(s) thereof, and hereby

authorizes the Commissioner of Patents and Trademarks to issue such

Letters Patent(s) to ASSIGNEE for the sole use of ASSIGNEE, its

successors or assigns.

INVENTORS further agree to execute, at the request and expense of

ASSIGNEE, such other formal documents as may be required to fully convey

the interest transferred herein and will similarly execute any patent

application papers (foreign or domestic) required for the filing of any

divisional, continuation, renewal or reissue of the patent application(s) or

resulting Letters Patent(s); and will generally do everything necessary or

desirable to obtain and enforce proper protection for the inventions assigned

hereby.

2 of 6

INVENTORS further assign to ASSIGNEE the whole right, title and interest in the inventions disclosed in the application(s) throughout all countries foreign to the United States. ASSIGNEE is hereby authorized to apply for patents relating to the inventions in its own name in countries where such procedure is proper; to claim the benefit of the International Convention; to file and prosecute International Applications relating to the inventions under the Patent Cooperation Treaty; and to file and prosecute applications relating to the inventions under the European Patent Convention. INVENTORS agree to execute application(s) relating to the inventions in those countries and under those conventions where it is necessary that the same be executed by the inventor, and to execute assignments of such applications and the resulting Letters Patent(s) to ASSIGNEE as well as all other necessary papers in relation to such applications and Letters Patent(s). INVENTORS hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country as proof of the right of ASSIGNEE to apply for patent and other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

To be binding on the heirs, assigns, representatives and successors of the undersigned and extend to the successors, assigns and nominees of the Assianee.

Dated: Jan. 29th, 2019 Signature: Satory Sugination

3 of 6

On this day before me personally appeared Satoru Sugimoto, known or identified to me (or proved to me on the basis of satisfactory evidence) to be the person whose name is subscribed within the Assignment, and acknowledged to me that he/she executed the Assignment in his/her authorized capacity, and that by his/her signature on the Assignment, the person executed the Assignment.

Witness	Name (printed): Shoji Eguchi
Witness	Signature: <u>logi Faul</u>
Date:	1/22/20/9
,,,,,,	, , , , , ,
	Name (printed): <u>Shoko Tomita</u>
Witness	Signature: <u>Ale Colt</u>
Date:	<u> </u>

4 of 6

Dated:	January 29 2019	Signature:	Hiroki Hosaka
--------	-----------------	------------	---------------

On this day before me personally appeared Hiroki Hosaka, known or identified to me (or proved to me on the basis of satisfactory evidence) to be the person whose name is subscribed within the Assignment, and acknowledged to me that he/she executed the Assignment in his/her authorized capacity, and that by his/her signature on the Assignment, the person executed the Assignment.

Witness Name (printed):	<u>Shoji Eauchi</u>
Witness Signature:	Liga Ega Lui
Date:	<u> </u>
	7
Witness Name (printed):	Shoko Tomita
Witness Name (printed): Witness Signature:	

Dated:	January 29 20/9	Signature	<u> Voyate</u> Hayato Oisi	<u>Qiahi</u> 11
--------	-----------------	-----------	-------------------------------	--------------------

On this day before me personally appeared Hayato Oishi, known or identified to me (or proved to me on the basis of satisfactory evidence) to be the person whose name is subscribed within the Assignment, and acknowledged to me that he/she executed the Assignment in his/her authorized capacity, and that by his/her signature on the Assignment, the person executed the Assignment.

Witness	Name (printed): Shoji Equchi
Witness	Signature: Sup Equilibrium
Date:	<u> </u>
	, , ,
Witness	Name (printed): Shoko Tomita
	Name (printed): Shoko Tomita Signature:

MI22-6791 2016-1365.00/US

RECORDED: 01/30/2019

6 of 6

PATENT REEL: 048191 FRAME: 0168